

ESD



TVS



TSS



MOV



GDT



PLED

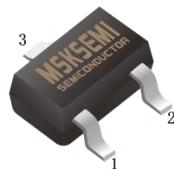
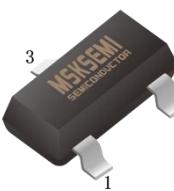
## **DTA143ZM/ZE/ZUA/ZKA/ZCA**

### **Product specification**

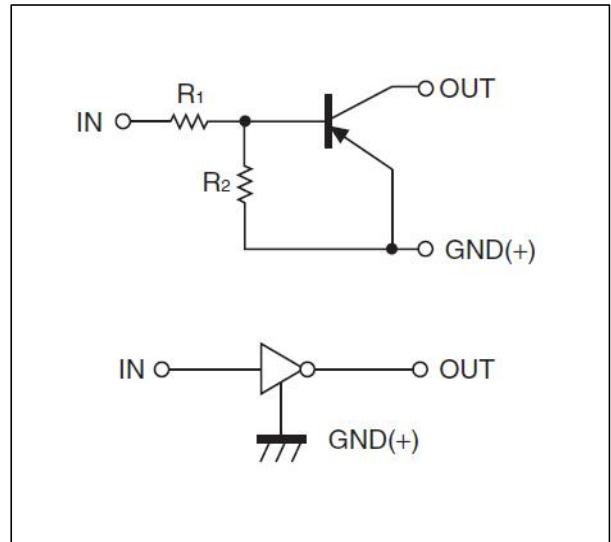
## Features

- Built-in bias resistors enable the configuration of an inverter circuit without connecting external input resistors (see equivalent circuit)
- The bias resistors consist of thin-film resistors with complete isolation to allow positive biasing of the input. They also have the advantage of almost completely eliminating parasitic effects
- Only the on/off conditions need to be set for operation, making device design easy

## Reference News

Pin Configuration	Marking
 1. IN 2. GND 3. OUT	SOT-723 <b>E13</b>
<b>DTA143ZM</b>	
 1. IN 2. GND 3. OUT	SOT-523 <b>E13</b>
<b>DTA143ZE</b>	
 1. IN 2. GND 3. OUT	SOT-323 <b>E13</b>
<b>DTA143ZUA</b>	
 1. IN 2. GND 3. OUT	SOT-23-3L <b>E13</b>
<b>DTA143ZKA</b>	
 1. IN 2. GND 3. OUT	SOT-23 <b>E13</b>
<b>DTA143ZCA</b>	

## Equivalent Circu



**ORDERING INFORMATION**

P/N	MARK	Package	Packing Method	Pack Quantity
DTA143ZM	E13	SOT-723	Reel	8000pcs/Reel
DTA143ZE	E13	SOT-523	Reel	3000pcs/Reel
DTA143ZUA	113	SOT-323	Reel	3000pcs/Reel
DTA143ZKA	E13	SOT-23-3L	Reel	3000pcs/Reel
DTA143ZCA	E13	SOT-23	Reel	3000pcs/Reel

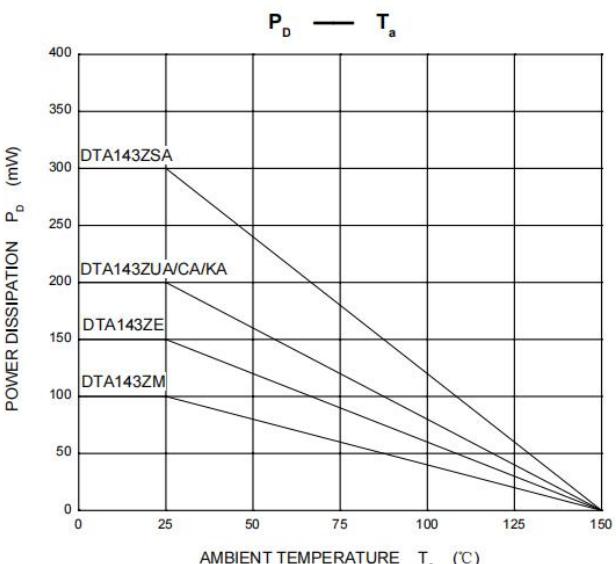
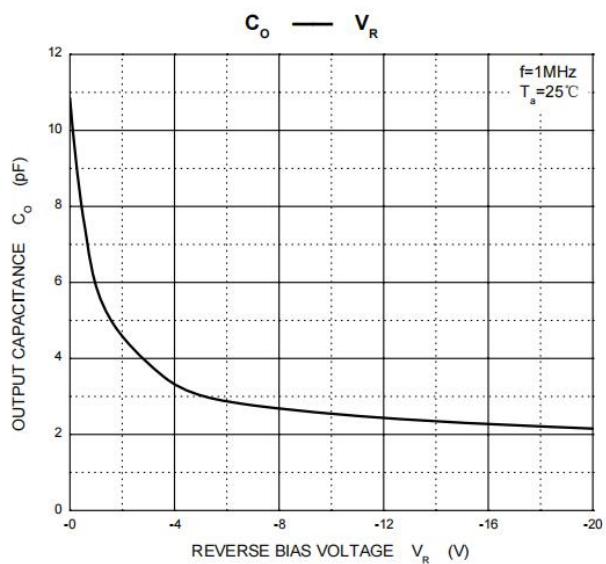
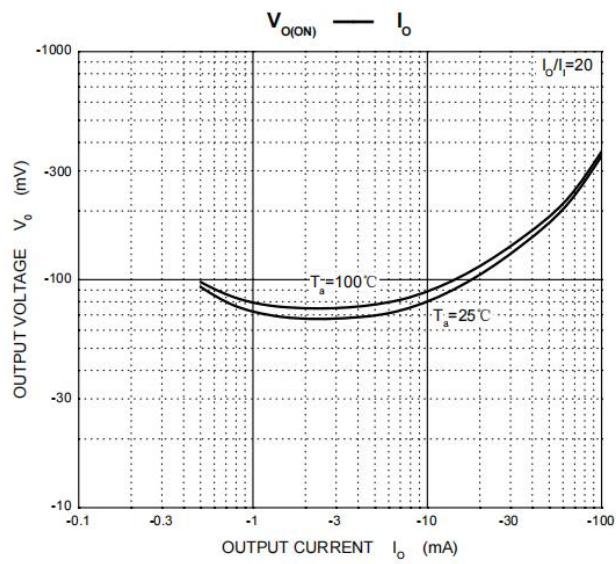
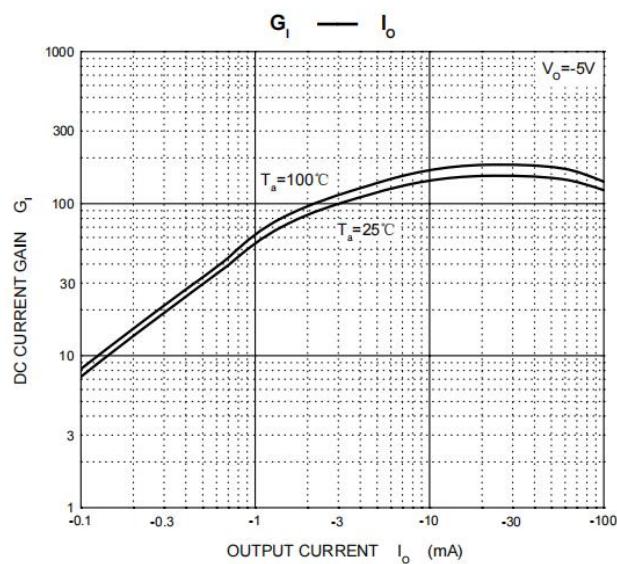
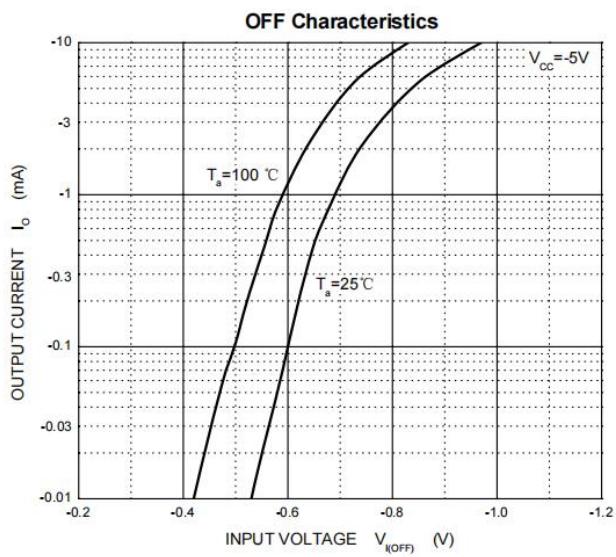
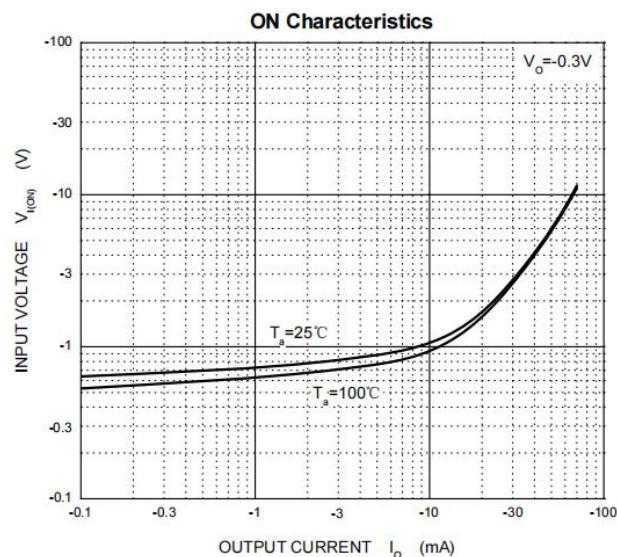
**MAXIMUM RATINGS(Ta=25°C unless otherwise noted)**

Symbol	Parameter	DTA143					Unit
		ZM	ZE	ZUA	ZKA	ZCA	
V <sub>cc</sub>	Supply Voltage			-50			V
V <sub>IN</sub>	Input Voltage			-30 ~ +5			V
I <sub>o</sub>	Output Current			-100			mA
P <sub>D</sub>	Power Dissipation	100	150	200	200	200	mW
T <sub>j</sub>	Junction Temperature			150			°C
T <sub>stg</sub>	Storage Temperature			-55 ~ +150			°C

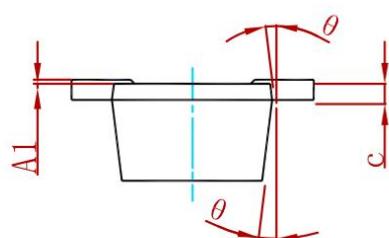
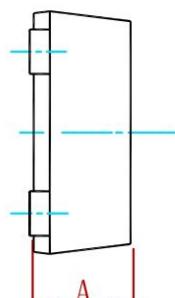
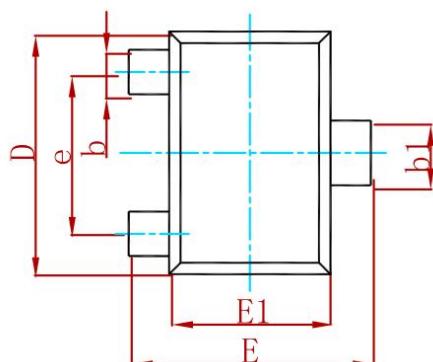
**ELECTRICAL CHARACTERISTICS (Ta=25°C unless otherwise specified)**

Parameter	Symbol	Conditions	Min	Typ	Max	Unit
Input voltage	V <sub>I(off)</sub>	V <sub>cc</sub> =-5V,I <sub>o</sub> =-100μA	-0.5			V
	V <sub>I(on)</sub>	V <sub>o</sub> =-0.3V,I <sub>o</sub> =-5mA			-1.3	V
Output voltage	V <sub>O(on)</sub>	I <sub>o</sub> /I <sub>i</sub> =-5mA/-0.25mA			-0.3	V
Input current	I <sub>i</sub>	V <sub>i</sub> =-5V			-1.8	mA
Output current	I <sub>O(off)</sub>	V <sub>cc</sub> =-50V,V <sub>i</sub> =0			-0.5	μA
DC current gain	G <sub>i</sub>	V <sub>o</sub> =-5V,I <sub>o</sub> =-10mA	80			
Input resistance	R <sub>i</sub>		3.29	4.7	6.11	kΩ
Resistance ratio	R <sub>2</sub> /R <sub>1</sub>		8	10	12	
Transition frequency	f <sub>T</sub>	V <sub>o</sub> =-10V,I <sub>o</sub> =-5mA,f=100MHz		250		MHz

## Typical Characteristics

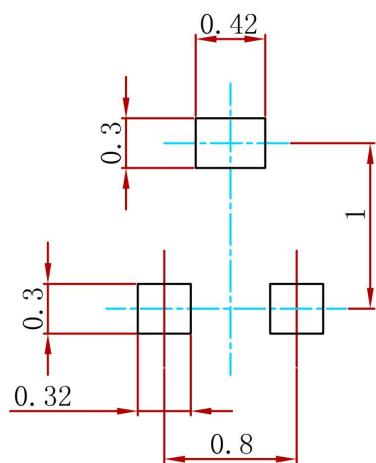


## PACKAGE MECHANICAL DATA



Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min.	Max.	Min.	Max.
A	0.430	0.500	0.017	0.020
A1	0.000	0.050	0.000	0.002
b	0.170	0.270	0.007	0.011
b1	0.270	0.370	0.011	0.015
c	0.080	0.150	0.003	0.006
D	1.150	1.250	0.045	0.049
E	1.150	1.250	0.045	0.049
E1	0.750	0.850	0.030	0.033
e	0.800TYP		0.031TYP	
θ	7° REF.		7° REF.	

## Suggested Pad Layout



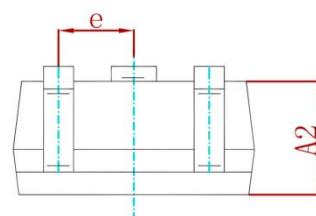
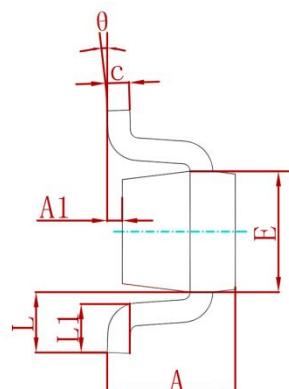
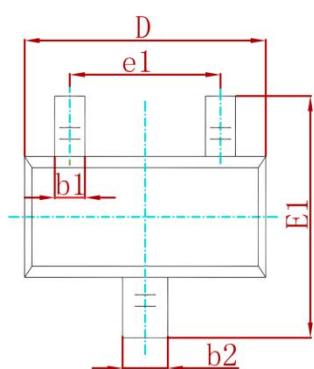
### Note:

1. Controlling dimension: in millimeters.
2. General tolerance:  $\pm 0.05\text{mm}$ .
3. The pad layout is for reference purposes only

## REEL SPECIFICATION

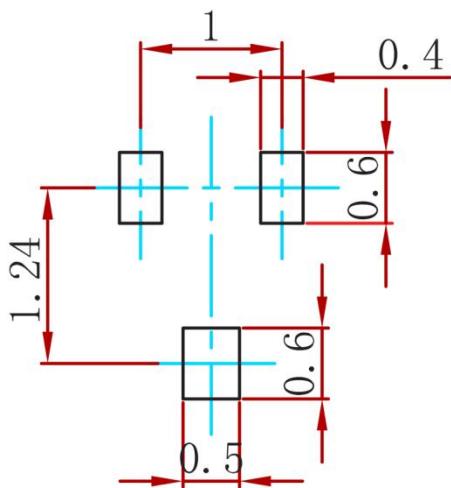
P/N	PKG	QTY
DTA143ZM	SOT-723	8000

## PACKAGE MECHANICAL DATA



Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min.	Max.	Min.	Max.
A	0.700	0.900	0.028	0.035
A1	0.000	0.100	0.000	0.004
A2	0.700	0.800	0.028	0.031
b1	0.150	0.250	0.006	0.010
b2	0.250	0.350	0.010	0.014
c	0.100	0.200	0.004	0.008
D	1.500	1.700	0.059	0.067
E	0.700	0.900	0.028	0.035
E1	1.450	1.750	0.057	0.069
e	0.500 TYP .		0.020 TYP .	
e1	0.900	1.100	0.035	0.043
L	0.400 REF .		0.016 REF .	
L1	0.260	0.460	0.010	0.018
9	0°	8°	0°	8°

## Suggested Pad Layout



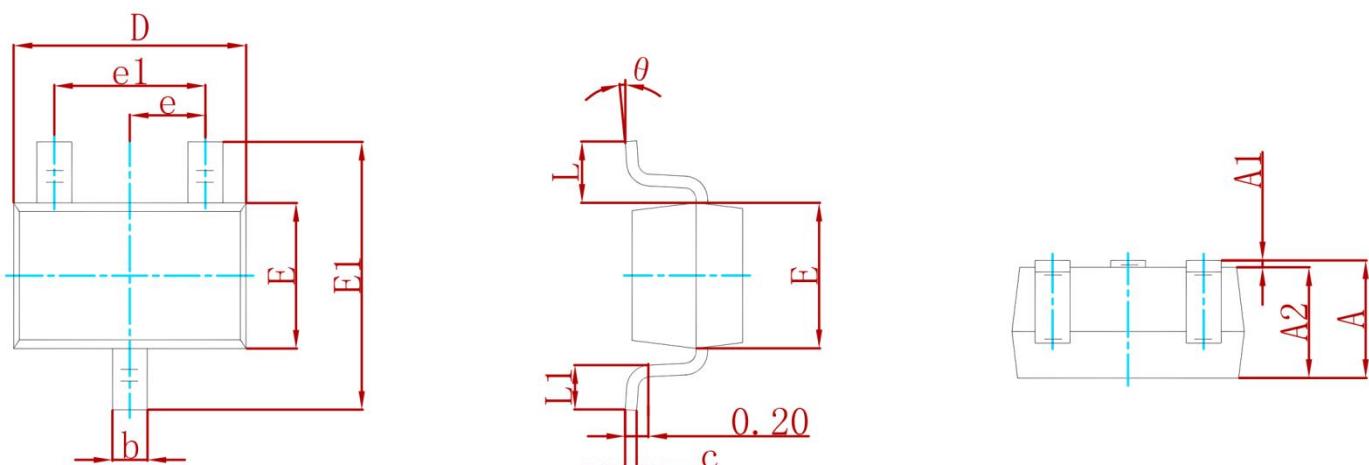
### Note:

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## REEL SPECIFICATION

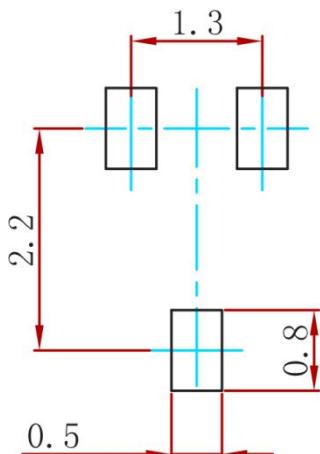
P/N	PKG	QTY
DTA143ZE	SOT-523	3000

## PACKAGE MECHANICAL DATA



Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min	Max	Min	Max
A	0.900	1.100	0.035	0.043
A1	0.000	0.100	0.000	0.004
A2	0.900	1.000	0.035	0.039
b	0.200	0.400	0.008	0.016
c	0.080	0.150	0.003	0.006
D	2.000	2.200	0.079	0.087
E	1.150	1.350	0.045	0.053
E1	2.150	2.450	0.085	0.096
e	0.650 TYP		0.026 TYP	
e1	1.200	1.400	0.047	0.055
L	0.525 REF		0.021 REF	
L1	0.260	0.460	0.010	0.018
9	0°	8°	0°	8°

## Suggested Pad Layout



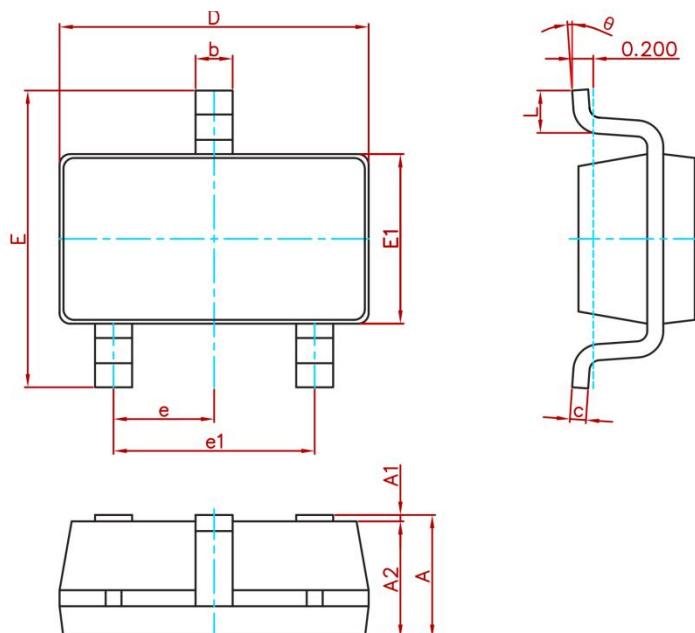
### Note:

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2. General tolerance:  $\pm 0.05\text{mm}$ .
3. The pad layout is for reference purposes only.

## REEL SPECIFICATION

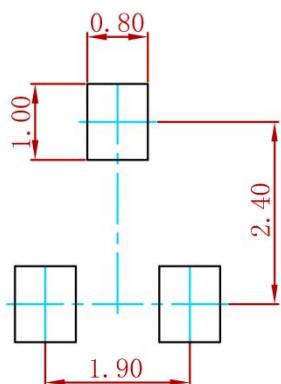
P/N	PKG	QTY
DTA143ZUA	SOT-323	3000

## PACKAGE MECHANICAL DATA



Symbol	Dimensions		Dimensions	
	In Min.	In Max.	In Min.	In Max.
A	1.050	1.250	0.041	0.049
A1	0.000	0.100	0.000	0.004
A2	1.050	1.150	0.041	0.045
b	0.300	0.500	0.012	0.020
c	0.100	0.200	0.004	0.008
D	2.820	3.020	0.111	0.119
E1	1.500	1.700	0.059	0.067
E	2.650	2.950	0.104	0.116
e	0.950(BSC)		0.037(BSC)	
e1	1.800	2.000	0.071	0.079
L	0.300	0.600	0.012	0.024
9	0°	8°	0°	8°

## Suggested Pad Layout



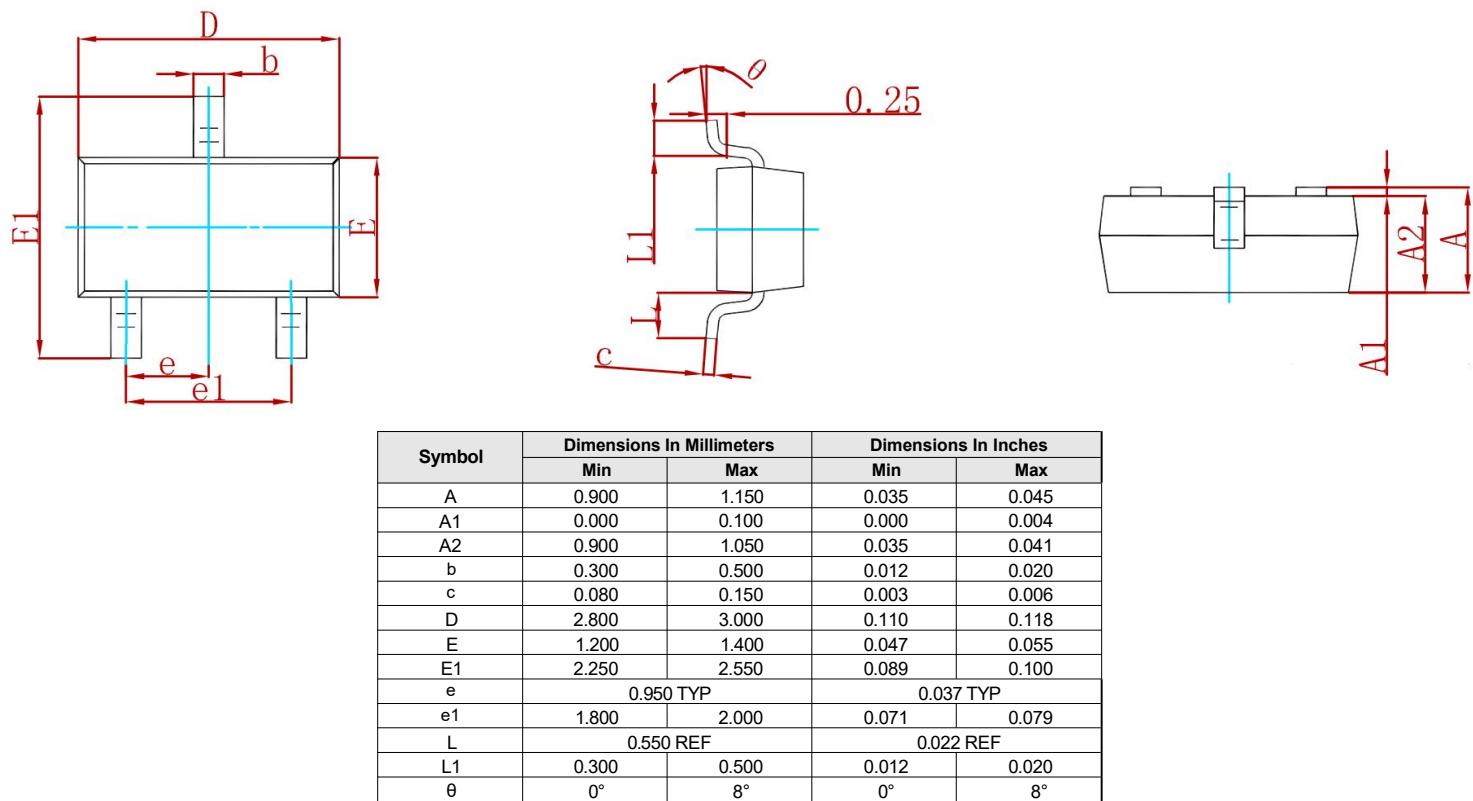
### Note:

1. Controlling dimension: in millimeters.
2. General tolerance:  $\pm 0.05$  mm.
3. The pad layout is for reference purposes only.

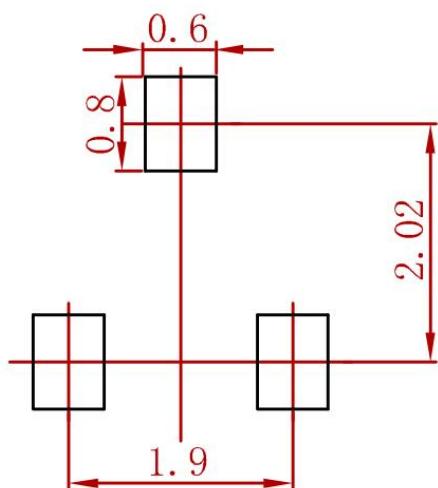
## REEL SPECIFICATION

P/N	PKG	QTY
DTA143ZKA	SOT-23-3L	3000

## PACKAGE MECHANICAL DATA



## Suggested Pad Layout



### Note:

1. Controlling dimension:in millimeters.
- 2.General tolerance: $\pm 0.05\text{mm}$ .
- 3.The pad layout is for reference purposes only.

## REEL SPECIFICATION

P/N	PKG	QTY
DTA143ZCA	SOT-23	3000

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